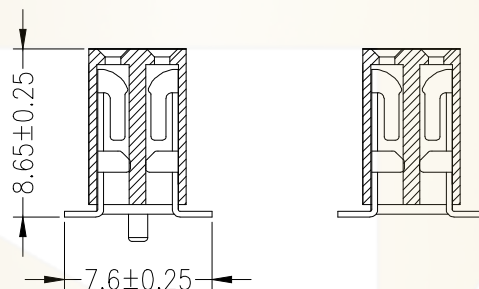
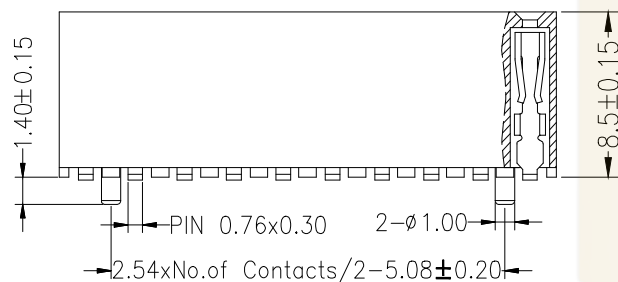
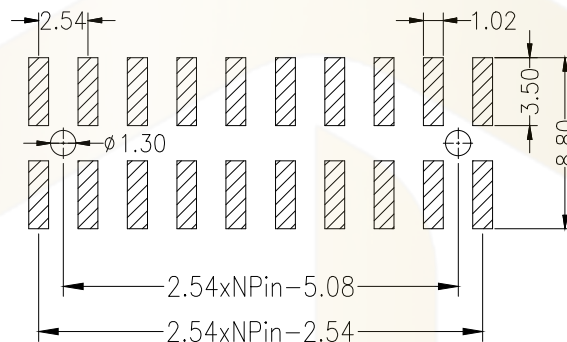
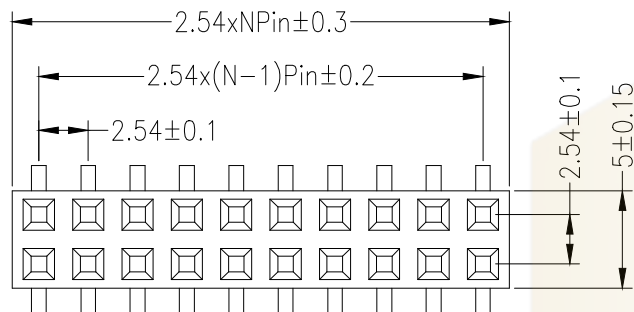


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)



P = With Post

默认 = W/O Post

SPECIFICATIONS

Rated Current: 3.0AMP

Contact Resistance: 20m Ω Max

Withstand Voltage: 1000V AC/DC

Insulation Resistance: 1000M Ω Min

Operation Temperature: -40°C to +105°C

Contact Material: Copper Alloy

Contact Plating: Au or Sn Over Ni

Insulator Material: Polyester(UL94V-0)

Max.Processing Temp:

(PA6T/LCP/PA9T)260°C $\pm 5^\circ\text{C}$ For 5~10 Second

Ordering Information

PM 254	- *	- N	- *	- *	- **	- LPT
No. of Rows 1=Single Row 2=Dual Row	No. of Pins Per Row 02-40Pin	Type 2=直针 8=弯针 S=立轴 W=弯轴	Length (mm)	Contact Plating G0:Gold Flash G1:1u" Gold G2:3u" Gold G3:5u" Gold G4:10u" Gold G5:15u" Gold G6:30u" Gold	Leak-Proof Tin (防漏锡)	

			GENERAL TOLERANCE		制图 DRAWING	深圳市华灿天禄电子有限公司 ShenzhenhuacantianluELECTRONICS CO., LTD			
			DIM TOL		审核 CHECK	产品名称 TITLE	2.54双排 贴片排母 防漏锡(塑高8.5)	版本 REV.	A
			X.X ± 0.30		批准 APPROVAL	产品料号 PART NO.	PM254-2-N-S-8.5-XX-LPT(L8.65)	单位 UNITS	mm
			X.XX ± 0.20		比例 SCALE	材料 MATERIAL		页次 SHEET	1/1
			X.XXX ± 0.10		投影 Projection				
1	初版发行		Angle $\pm 3.0^\circ$						
序号 No.	变更内容 MODIFY CONTENT	日期 MODIFY DATE							